

# APPROVAL SHEET

# MR12, MR08, MR06, MR04

±1%, ±5%

Thick film General Purpose Chip Resistors Size 1206, 0805, 0603, 0402 Automotive & Military Compliant RoHS Exemption Free Lead<100ppm

\*Contents in this sheet are subject to change without prior notice.



#### **FEATURE**

- 1. High reliability and stability ±1%
- 2. Automotive AEC Q-200 & Military MIL-STD Compliant
- 3. 100% CCD inspection
- 4. RoHS Exemption free and Halogen free products

#### **APPLICATION**

- Automotive application
- Consumer electrical equipment
- EDP, Computer application
- Telecom application

#### **DESCRIPTION**

The LEAD FREE resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a LEAD FREE resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. For all series, overcoat is WATER BLUE color. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

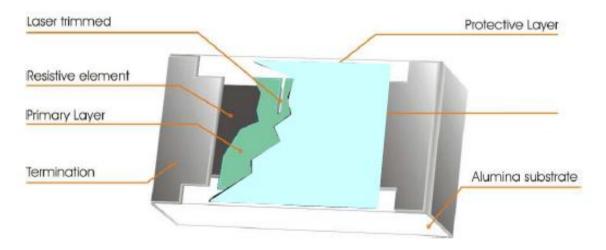


Fig 1. Construction of a Chip-R

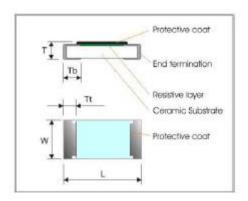


#### **QUICK REFERENCE DATA**

Item	General Specification							
Series No.	MR12		MR08		MR06		MR04	
Size code	1206(	1206(3216) 0805(2012) 0603(1608) 0402(1005)					1005)	
Resistance Range			1Ω~10Ms	Ω (±5% tol	erance), Ju	ımper		
			1Ω~	10MΩ (±1%	% tolerance	<del>)</del> )		
Resistance Tolerance	±1%	±1% ±5% ±1% ±5% ±1% ±5% ±1% ±				±5%		
	E96/E24	E24	E96/E24	E24	E96/E24	E24	E96/E24	E24
TCR (ppm/°C)								
R > 1MΩ	$\leq \pm 200$ $\leq \pm 200$ $\leq \pm 200$ $\leq \pm 200$			200				
$10\Omega < R \le 1M\Omega$	$\leq \pm 100$ $\leq \pm 100$ $\leq \pm 100$ $\leq \pm 100$							
$R \le 10\Omega$	-200~+400 -200~+400 -200~+400 -200~+400							
Max. dissipation @ T <sub>amb</sub> =70°C	1/4 W 1/8 W 1/10 W 1/16 W			6 W				
Max. Operation Voltage	200V		150V		75V		50V	
Max. Overload Voltage	400V 300V 150V 100V			0V				
Operation temperature		-55/+155C						

#### Note:

- Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by
   RCWV = √RatedPower × Resistance Value or Max. RCWV listed above, whichever is lower.
- 2. The resistance of Jumper is defined  $< 0.05\Omega$ .



### **DIMENSIONS (unit:mm)**

	MR12	MR08	MR06	MR04
L	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10	1.00 ± 0.05
W	1.60 ± 0.10	1.25 ± 0.10	$0.80 \pm 0.10$	$0.50 \pm 0.05$
Т	$0.60 \pm 0.15$	$0.50 \pm 0.15$	$0.45 \pm 0.15$	$0.35\pm0.05$
Tb	$0.45 \pm 0.20$	$0.40 \pm 0.20$	$0.30 \pm 0.15$	0.25 ± 0.10
Tt	$0.50 \pm 0.20$	$0.40 \pm 0.20$	$0.30 \pm 0.10$	0.20 ± 0.10

No MARKING for all series.



#### **FUNCTIONAL DESCRIPTION**

#### Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of  $\pm 5\%$ , and E24+E96 series for resistors with a tolerance of  $\pm 1\%$ . The values of the E24/E96 series are in accordance with "IEC publication 60063".

#### **Derating**

The power that the resistor can dissipate depends on the operating temperature; see Fig.2.1

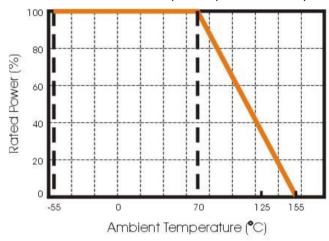


Figure 2.1 Maximum dissipation in percentage of rated power as a function of the ambient temperature

#### **MOUNTING**

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



#### **SOLDERING CONDITION**

The robust construction of chip resistors allows them to be completely immersed in a solder bath 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

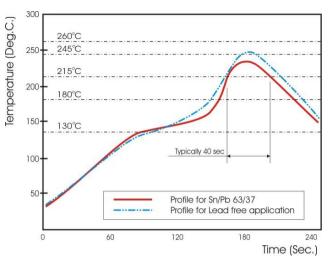


Fig 3. Infrared soldering profile for Chip Resistors

#### **CATALOGUE NUMBERS**

The resistors have a catalogue number starting with .

MR12	х	472_	J	Т	R
MR12 Automotive code MR12: 1206 MR08: 0805 MR06: 0603 MR04: 0402	Type code X: $\pm 5\%$ , $1\Omega \sim 10 M\Omega$ $\pm 1\%$ , $10\Omega \sim 1 M\Omega$ W: $\pm 1\%$ , $< 10\Omega$ ; $> 1 M\Omega$	Resistance code  ±5%, E24: 2 significant digits followed by no. of zeros and a blank $220\Omega = 221_{-}$ $4K7 = 472_{-}$ $10\Omega = 100_{-}$ $1\Omega = 1R0_{-}$ ("_" means a blank)  Resistance code  ±1%, E24+E96: 3 significant digits followed by no. of zeros  E96: $37.4K\Omega = 3742$ E24: $220\Omega = 2200$ $4K7 = 4701$ $10\Omega = 10R0$ $1\Omega = 1R00$	Tolerance F:±1% J:±5% P:Jumper	Packaging code T: 7" Reeled taping D: 7" Reel 20K/RL 0402 size Q: 10" Reeled taping G: 13" Reeled taping B: Bulk	Termination code  R = Lead free LEAD<100ppm

#### MR12,MR08,MR06:

1. Reeled tape packaging: 8mm width paper taping 5000pcs per 7" reel, 10kpcs per 10" reel, 20kpcs per 13" reel.

2. Bulk packaging : 5000pcs per poly-bag

#### MR04:

1. Reeled tape packaging : 8mm width paper taping 10,000pcs per reel,

2. Bulk packaging : 10,000pcs per poly-bag



#### **TEST AND REQUIREMENTS**

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, sub-clause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

TECT	PROCEDURE / TEST METUOR	REQUIREMENTS		
TEST	PROCEDURE / TEST METHOD	Resistance	0Ω	
Electrical Characteristics  JISC5201-1: 1998  Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $ \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \; \text{(ppm/°C)}  t_1 : 20^\circ\text{C} + 5^\circ\text{C} - 1^\circ\text{C} \\ R_1 : \text{Resistance at reference temperature} \\ R_2 : \text{Resistance at test temperature} \\ \text{Un-mounted chips completely immersed for } 10 \pm 1 \text{second in a} $	Within the specified tolerance Refer to "QUICK REFERENCE Do		
Resistance to soldering heat (R.S.H) MIL-STD-202 method 210	SAC solder bath at 270°C±5°C	No visible damage	<50mΩ	
Solderability J-STD-002	a) Bake the sample for 155°C dwell time 4hrs/ solder dipping 235°C/5sec. b) Steam the sample dwell time 8 hrs/ solder dipping 215°C/5sec. c) Steam the sample dwell time 8 hrs/ solder dipping 260°C/7sec.	95% coverage min., good tir no visible damage	nning and	
Temperature cycling JESD22 method JA-104	1000 cycles, -55°C ~ +155°C, dwell time 30min	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Moisture Resistance MIL-STD-202 method 106	65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Bias Humidity MIL-STD-202 method 103	1000+48/-0 hours; 85°C, 85% RH, 10% of operation power	$\Delta$ R/R max. $\pm$ (1%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Operational Life MIL-STD-202 method 108	1000+48/-0 hours; 35% of operation power, 125±2°C	$\Delta$ R/R max. $\pm$ (1%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Short Time Overload JIS C 5201-1 Clause 4.13	Permanent resistance change after a 5 second application of a voltage 2.5 times rated voltage or max. overload voltage, whichever is less.	$\Delta$ R/R max. $\pm$ (2%+0.1 $\Omega$ ) No visible damage	<50mΩ	



TEST	DDOOEDUDE / TEST METUOD	REQUIREMENTS			
TEST	PROCEDURE / TEST METHOD	Resistance ±5%, ±1%	0Ω		
High Temperature	1000+48/-0 hours; without load in a temperature chamber	$\Delta$ R/R max. $\pm$ (1%+0.05 $\Omega$ )			
Exposure	controlled 155±3°C	No visible damage	<50mΩ		
MIL-STD-202			<301112		
method 108					
Mechanical Shock	Test ½ Sine Pulse/ 1500g peak/ normal duration: 6ms/ Velocity: 15.4ft/sec. Three shocks in each direction, total 18	Within the specified			
MIL-STD-202	shocks.	tolerance.	$<$ 50m $\Omega$		
method 213		No visible damage			
Board Flex	Resistors mounted on a 90mm glass epoxy resin PCB(FR4),	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ).	<50mΩ		
AEC-Q200-005	bending once 2mm for 10sec	No visible damage	<2011107		
Terminal strength	Pressurizing force: 1.8Kg ( 1Kg for 0402 ), Test time: 60±1sec.	c. No remarkable damage or remova			
AEC-Q200-006		the			
		terminations			
Resistance to Solvents			No superficial defect on marking, encapsulation, coating, appearance.		
MIL-STD-202	brush 10 strokes with a toothbrush with a handle made of a non-reactive material (wet bristle), immersion and brush 3	Electrical characteristics within			
Method 215	times and then air blow dry products specification a				
		Inspect at 3X max. for marking	ıg,		
		inspect at 10X for part damag	je.		
Vibration	Test 5g's for 20min., 12 cycles each of 3 orientations	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ )			
MIL-STD-202		No visible damage	$<$ 50m $\Omega$		
method 204					
Thermal shock	Test –55 to 155°C/ dwell time 15min/ Max transfer time 20sec	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )			
MIL-STD-202	300cycles	No visible damage	$<$ 50m $\Omega$		
method 107					
ESD	Test contact 1.0KV ( 0.5KV for 0402 only) $\Delta R/R \text{ max. } \pm (1\% + 0.05\Omega)$		<50mΩ		
AEC-Q200-002	No visible damage		<b>\</b> 0011122		

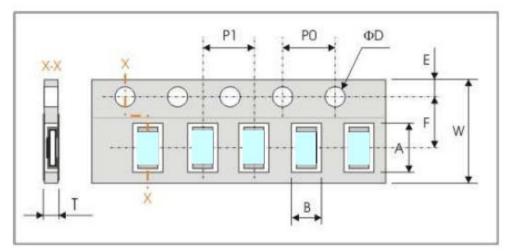
## TEST CONDITION FOR JUMPER (0 $\Omega$ )

Item	MR12	MR08	MR06	MR04
Power Rating At 70°C	1/4W 1/8W 1/10W 1/			
Resistance	MAX.50m $Ω$			
Rated Current	2.2A	1.6A	1.4A	1.1A
Peak Current	4.4A 3.2A 2.8A 2		2.2A	
Operating Temperature	-55 ~ +155°C			



#### **PACKAGING**

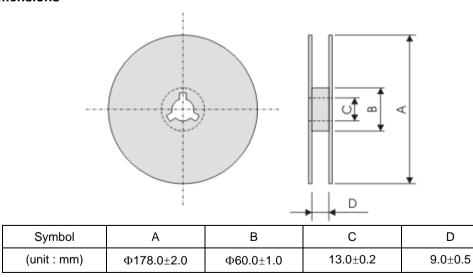
#### Paper Tape specifications (unit :mm)



Series No.	А	В	W	F	E
MR12	3.60±0.20	2.00±0.20			
MR08	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.20	1 75   0 10
MR06	1.90±0.20	1.10±0.20	6.00±0.30	3.50±0.20	1.75±0.10
MR04	1.20±0.10	0.70±0.10			

Series No.	P1	P0	ΦD	Т
MR12/08	4.00+0.40			Max. 1.0
MR06	4.00±0.10	4.00±0.10	$\Phi$ 1.50 $^{+0.1}_{-0.0}$	0.65±0.05
MR04	2.00±0.10			0.40±0.05

#### 7" Reel dimensions



# 单击下面可查看定价,库存,交付和生命周期等信息

>>Walsin Technology(华新科技)